



DMPH6050SFGQ

60V P-CHANNEL +175°C MOSFET PowerDI3333-8

Product Summary

| BV _{DSS} | R _{DS(ON)} Max | I _D Max T _C = +25°C | | |
|-------------------|--------------------------------|----------------------------------------------|--|--|
| -60V | $50m\Omega @ V_{GS} = -10V$ | -18A | | |
| -007 | 70mΩ @ V _{GS} = -4.5V | -15A | | |

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} ensures on state losses are minimized
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: PowerDl[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.072 grams (Approximate)



Ordering Information (Note 5)

| | | |
|-----------------|---------------|-------------------|
| Part Number | Case | Packaging |
| DMPH6050SFGQ-7 | PowerDI3333-8 | 2,000/Tape & Reel |
| DMPH6050SFGQ-13 | PowerDI3333-8 | 3,000/Tape & Reel |

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

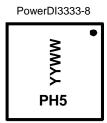
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



PH5= Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)

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Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|-----------------------------------------------------------------|------------------|---------------------------------------------------|-----------------|--------------|----|
| Drain-Source Voltage | V _{DSS} | -60 | V | | |
| Gate-Source Voltage | V _{GSS} | ±20 | V | | |
| Continuous Drain Current (Note 7) V_{GS} = -10V | Steady State | T _A = +25°C T _A = +100°C | ID | -6.1 -4.2 | A |
| Continuous Drain Current (Note 8) V_{GS} = -10V | Steady State | T _C = +25°C T _C = +100°C | ID | -18 -12 | A |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | I _{DM} | -32 | А | | |
| Maximum Continuous Body Diode Forward Current (| Is | -2 | A | | |
| Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%) | | | I _{SM} | -32 | А |
| Avalanche Current (Note 9) L = 0.1mH | | | I _{AS} | -24.8 | А |
| Avalanche Energy (Note 9) L = 0.1mH | | | E _{AS} | 30.8 | mJ |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit |
|--------------------------------------------------|-----------------|-----------------------|-------------|------|
| Total Power Dissipation (Note 6) | | PD | 1.2 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady state | D | 125 | °C/W |
| Thermal Resistance, Junction to Amblent (Note 6) | t<10s | $R_{	extsf{	heta}JA}$ | 85 | |
| Total Power Dissipation (Note 7) | | PD | 2.8 | W |
| Thermal Resistance, Junction to Ambient (Note 7) | Steady state | P | 54 | °C/W |
| Thermal Resistance, Junction to Amblent (Note 7) | t<10s | $R_{	heta}JA$ | 37 | |
| Thermal Resistance, Junction to Case (Note 8) | $R_{\theta JC}$ | 6 | | |
| Operating and Storage Temperature Range | | TJ, TSTG | -55 to +175 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--------------------------------------------------------|---------------------|-----|------|------|-------|---------------------------------------------------------------|--|
| OFF CHARACTERISTICS (Note 10) | | | - | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -60 | _ | — | V | $V_{GS} = 0V, I_D = -250 \mu A$ | |
| Zero Gate Voltage Drain Current T _J = +25°C | I _{DSS} | | — | -1 | μA | $V_{DS} = -60V, V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | - | — | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 10) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | -1 | — | -3 | V | $V_{DS} = V_{GS}, I_D = -250 \mu A$ | |
| Static Drain-Source On-Resistance | | - | 41 | 50 | mΩ | $V_{GS} = -10V, I_D = -7A$ | |
| Static Drain-Source On-Resistance | R _{DS(ON)} | | 52 | 70 | 11122 | $V_{GS} = -4.5V, I_D = -7A$ | |
| Diode Forward Voltage | V _{SD} | — | -0.7 | -1.2 | V | $V_{GS} = 0V, I_{S} = -1A$ | |
| DYNAMIC CHARACTERISTICS (Note 11) | | | | | | | |
| Input Capacitance | C _{iss} | | 1293 | — | pF | | |
| Output Capacitance | Coss | | 86.3 | _ | pF | − V _{DS} = -30V, V _{GS} = 0V, − f = 1MHz | |
| Reverse Transfer Capacitance | C _{rss} | _ | 64.7 | | pF | | |
| Gate Resistance | Rg | — | 12 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | |
| Total Gate Charge (V _{GS} = -4.5V) | Qg | _ | 11.9 | — | nC | | |
| Total Gate Charge (V _{GS} = -10V) | Qg | — | 24.1 | — | nC | | |
| Gate-Source Charge | Q _{gs} | _ | 3.6 | — | nC | $V_{DS} = -30V, I_D = -5A$ | |
| Gate-Drain Charge | Q _{qd} | | 5.7 | — | nC | 7 | |
| Turn-On Delay Time | t _{D(ON)} | | 4.3 | _ | ns | V _{DS} = -30V, V _{GS} = -10V, | |
| Turn-On Rise Time | t _R | | 6.3 | _ | ns | | |
| Turn-Off Delay Time | t _{D(OFF)} | _ | 46.7 | _ | ns | $R_G = 3\Omega$, $I_D = -5A$ | |
| Turn-Off Fall Time | tF | | 25.3 | _ | ns | 1 | |
| Body Diode Reverse Recovery Time | t _{RR} | _ | 13.6 | _ | ns | −I _F = -5A, di/dt = 100A/µs | |
| Body Diode Reverse Recovery Charge | Q _{RR} | _ | 7.4 | — | nC | | |

Notes: 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

Device mounted on FR-4 re board, with minimum recommended part adjust, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad).
I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.

10. Short duration pulse test used to minimize self-heating effect.

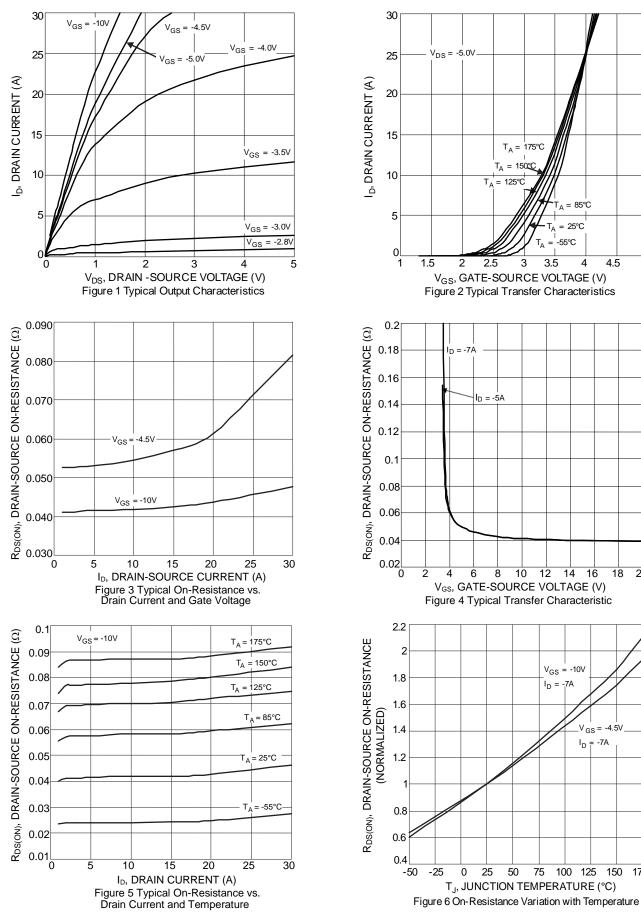
11. Guaranteed by design. Not subject to product testing.





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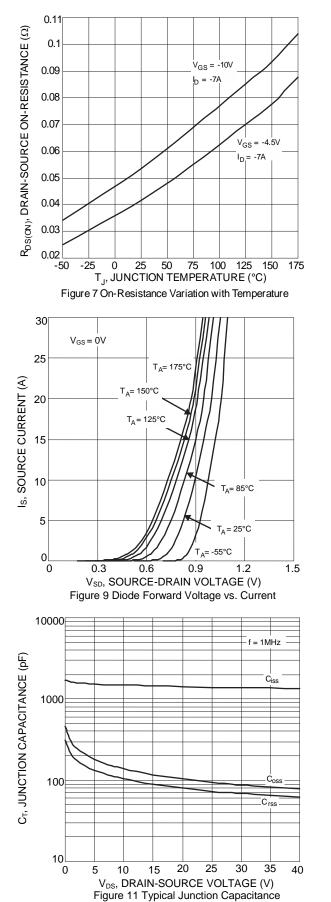
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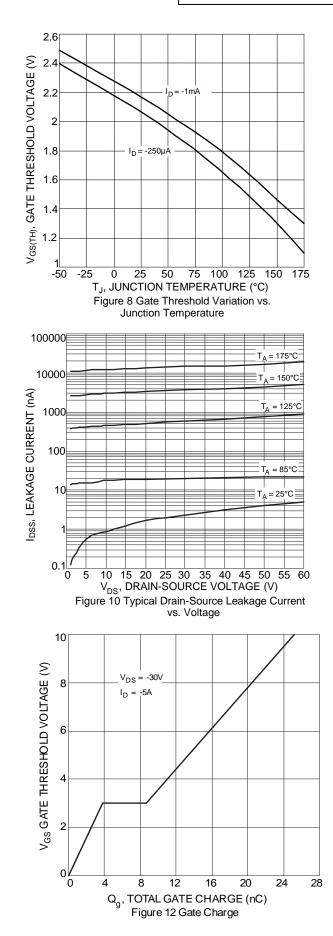


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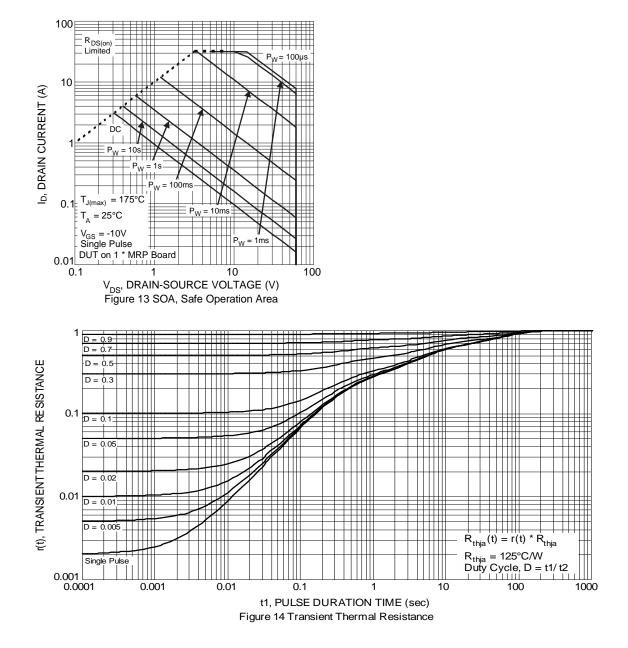
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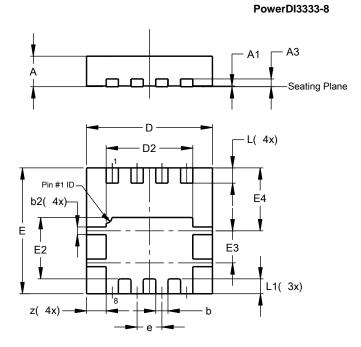






Package Outline Dimensions

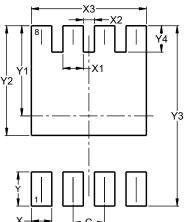
Please see http://www.diodes.com/package-outlines.html for the latest version.



| | PowerDI3333-8 | | | | | | |
|-------|----------------------|------|-------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 0.75 | 0.85 | 0.80 | | | | |
| A1 | 0.00 | 0.05 | 0.02 | | | | |
| A3 | - | - | 0.203 | | | | |
| b | 0.27 | 0.37 | 0.32 | | | | |
| b2 | 0.15 | 0.25 | 0.20 | | | | |
| D | 3.25 | 3.35 | 3.30 | | | | |
| D2 | 2.22 | 2.32 | 2.27 | | | | |
| Е | 3.25 | 3.35 | 3.30 | | | | |
| E2 | 1.56 | 1.66 | 1.61 | | | | |
| E3 | 0.79 | 0.89 | 0.84 | | | | |
| E4 | 1.60 | 1.70 | 1.65 | | | | |
| е | 1 | - | 0.65 | | | | |
| L | 0.35 | 0.45 | 0.40 | | | | |
| L1 | _ | - | 0.39 | | | | |
| Z | _ | _ | 0.515 | | | | |
| All I | All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI3333-8

| Dimensions | Value (in mm) | | | |
|------------|---------------|--|--|--|
| С | 0.650 | | | |
| Х | 0.420 | | | |
| X1 | 0.420 | | | |
| X2 | 0.230 | | | |
| X3 | 2.370 | | | |
| Y | 0.700 | | | |
| Y1 | 1.850 | | | |
| Y2 | 2.250 | | | |
| Y3 | 3.700 | | | |
| Y4 | 0.540 | | | |

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